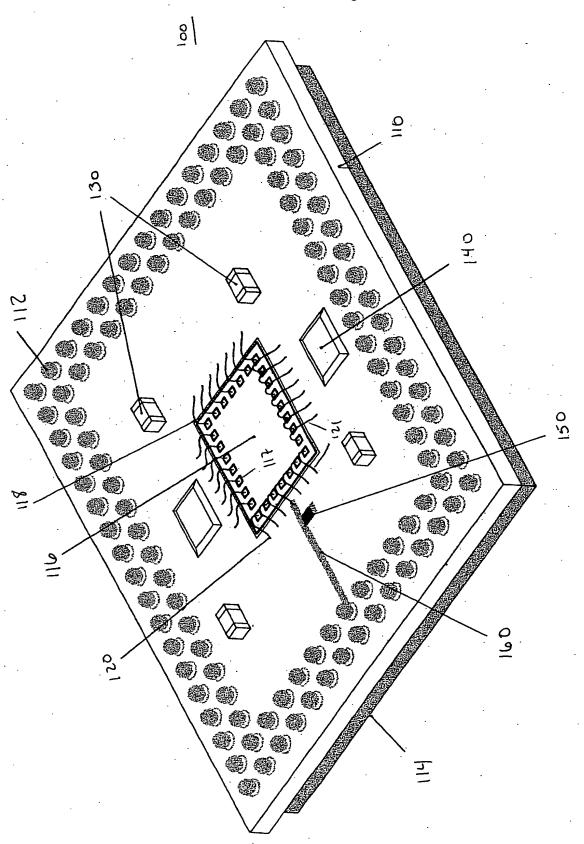
Title: Method And Apparatus For High Electrical And Thermal Performance...

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	Form thick film substrate - 210	in the second
	Laser Cut IC cavity - 220	
	Form transmission lines	
	on substrate - 230	
	Form passive components - 240	
	substrate -240	
	Attack neat sink or heat spreader	250
	ar heat spreader within - 260	
·	I.C. cavity	
	Wirebond Ic pads to - 270	
	pads on substrate	
	Attach discrete ICor other components to -280	
	substrate	
	Encapsulate package components -	290
	Attach BGA solder spheres -295	
	William 2511 3013 Spranger	
•	Figure 2	THE PERMIT